

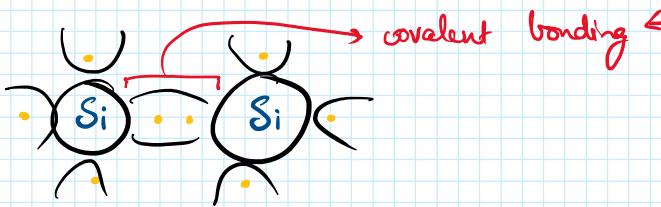
SEMICONDUCTORS

- Neither fully a conductor nor an insulator

Looking at two examples,

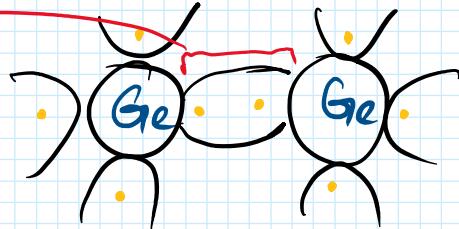
Si

- 4 valence electrons



Ge

- 4 valence electrons



TYPES OF SEMICONDUCTORS

Intrinsic: Pure semiconductor, no impurities

Extrinsic: External impurities are added

n-type

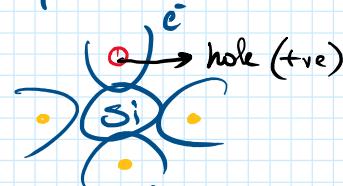
- pentavalent impurity } antimony, arsenic
added phosphorus
- n → negative → one extra e⁻



- majority charge carrier: electrons

p-type

- trivalent impurity } Boron, gallium, indium
added
- p → positive → one less e⁻



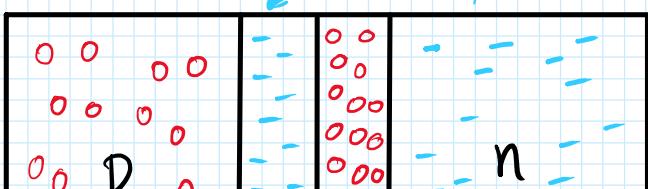
- majority charge carrier: holes/voids

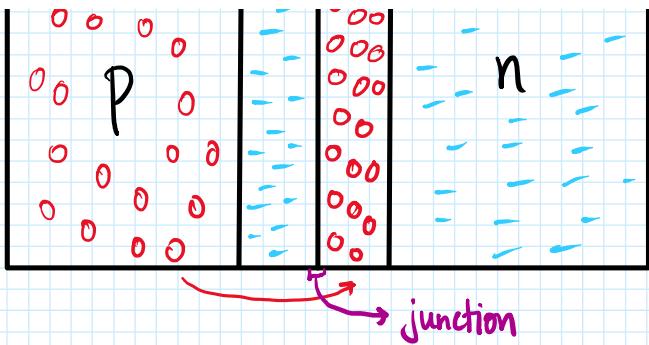
DIODES



- has anode, cathode → 2 electrodes
- combination of p-type, n-type; forms a depletion region at their junction
- allows current flow in one direction only (forward bias)

list of types of diodes, symbols, characteristics





P-N JUNCTION DIODE

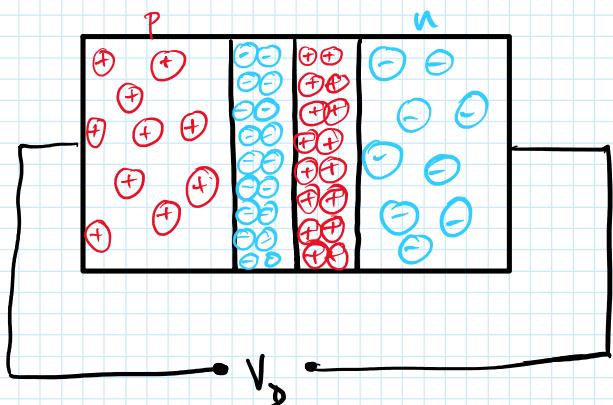
- After joining p-type, n-type, electrons from n-type near junction diffuse into p-region.
- Similarly, holes from p move into n region.
- This forms the depletion region.

→ creates a potential barrier, which has to be overcome by an external voltage source for flow of charges

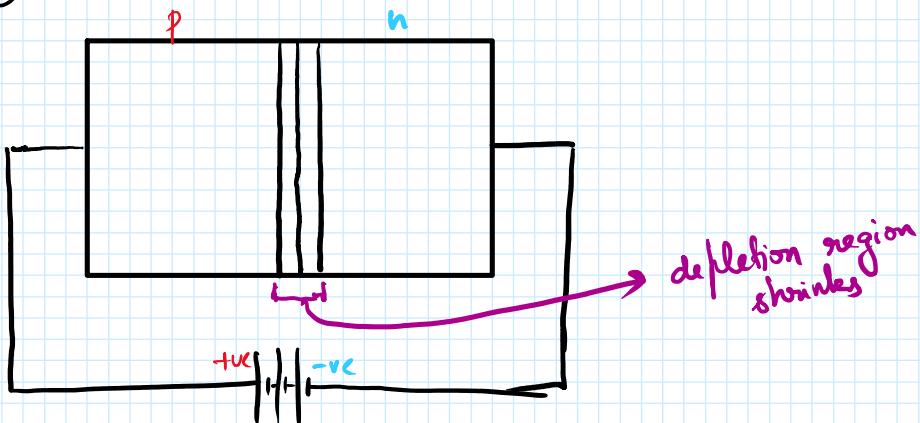
DIODE BIASING

→ process of applying external voltage

① No bias

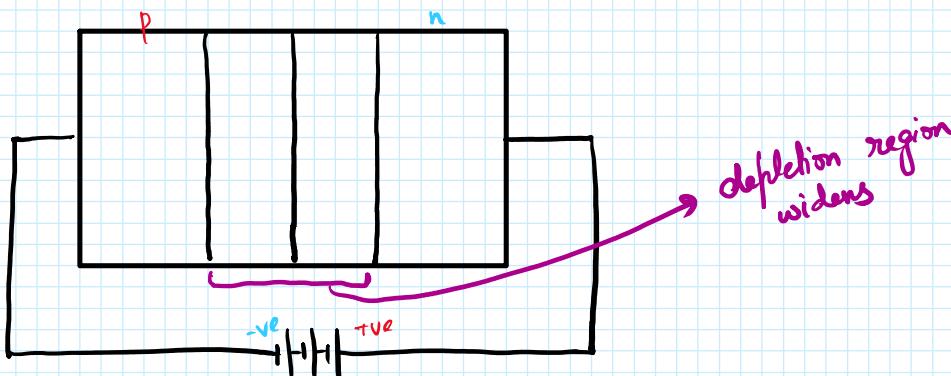


② Forward bias

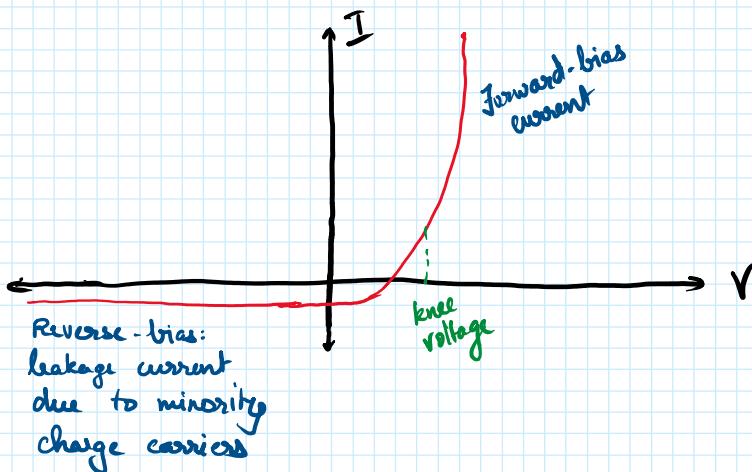




③ Reverse bias



FORWARD & REVERSE CHARACTERISTICS



Forward characteristics

- **Knee voltage / cut-in voltage:** Forward voltage at which conduction happens and current starts rising rapidly.
- Conduction does not occur on a significant scale until knee voltage is reached.
- Knee voltage for:

$\text{Si} \rightarrow 0.7\text{V}$	$\text{GaAs} \rightarrow 1.2\text{V}$
$\text{Ge} \rightarrow 0.3\text{V}$	
- **Forward current rating:** Current that flows in forward direction when diode is in forward bias
- **Max. power dissipation:** Max. power a diode can dissipate without damaging the device itself

Reverse characteristics

- **Reverse saturation current:** Reverse current caused by diffusion of minority charge carriers. Also called **leakage current**.

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- **Reverse breakdown voltage**: If large enough negative potential is applied, it will allow current flow in the reverse direction.
- **Peak inverse voltage rating**: Maximum voltage a diode can withstand in reverse bias condition before break down.

SHOCKLEY'S CURRENT EQUATION / DIODE EQUATION

to find current through diode at a certain temperature

- When V_D is negative

$$I_D \sim I_s$$

- When V_D is positive

$$I_D \sim I_s e^{\frac{qV_D}{nKT}}$$

In general,

$$I_D = I_s [e^{\frac{qV_D}{nKT}} - 1]$$

Annotations:

- diode current
- saturation current
- charge on diode = $1.6 \times 10^{-19} C$
- diode voltage
- Temperature in Kelvin
- K: Boltzmann's constant
 $K = 1.380 \times 10^{-23} J/K$
- n: ideality factor
- $n=1$] indirect semiconductors $\rightarrow Si, Ge$
- $n=2$] direct $\rightarrow GaAs, InP$

Here we have

$$\text{Thermal voltage } V_{th} = \frac{kT}{q}$$

Substituting this in our equation, we get

$$I_D = I_s [e^{\frac{V_D}{nV_{th}}} - 1]$$

At $T = 300K$,

$$V_{th} = \frac{kT}{q} = \frac{1.38 \times 10^{-23} \times 300}{1.6 \times 10^{-19}}$$

NOTE: Direct and indirect band gap semiconductors

CBM \rightarrow conduction band minimum \rightarrow min. energy e^- in conduction band can have VBM \rightarrow valence band maximum \rightarrow max. energy e^- in valence band can have k \rightarrow momentum of e^- in crystal lattice

Direct: CBM and VBM both occur at same k. Eg: LEDs, lasers

Indirect: CBM and VBM occur at different k. Eg: Transistors

NOTE: What is thermal voltage?

Voltage produced within the p-n junction diode due to the action of temperature.

$$q = \frac{1.6 \times 10^{-19}}{V}$$

$$[V_{th}]_{300K} = 0.0258 V = 25.8 \text{ mV} \approx 26 \text{ mV}$$

V_{th} at room temperature

NUMERICAL

- ① Calculate forward bias current of Si diode when forward bias voltage of 0.4 V is applied, the reverse saturation current is $1.17 \times 10^{-9} \text{ A}$ and thermal voltage is 25.2 mV.

Soln.

$$I_s = I_D [e^{\frac{V_a}{nV_{th}}} - 1]$$

Substituting,

$$I_s = 1.17 \times 10^{-9} [e^{\frac{0.4}{(1)(0.0252)}} - 1]$$

$$\underline{I_s = 9.15 \times 10^{-3} \text{ A}}$$